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APPLICATION NO. FILING DATE		LING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
09/731,889	ı	2/07/2000	Shinji Isokawa	362-51 1026		
33769	7590	03/26/2003				
BODNER (	& O'ROU	RKE, LLP	EXAMINER			
425 BROAD	HOLLOW	ROAD, SUITE 10				
MELVILLE	, NY 117	47		LOUIE, WAI SING		
				ART UNIT	PAPER NUMBER	
				2814		
				DATE MAILED: 03/26/2003		

Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	Applicant(s)					
•	09/731,889	ISOKAWA, SHINJI	. V				
Office Action Summary	Examiner	Art Unit					
omeomen cumus,	Wai-Sing Louie	2814					
Th MAILING DATE of this commun			dr ss				
Period for Reply	• •						
A SHORTENED STATUTORY PERIOD F THE MAILING DATE OF THIS COMMUNI  - Extensions of time may be available under the provisions after SIX (6) MONTHS from the mailing date of this comm  - If the period for reply specified above is less than thirty (3  - If NO period for reply is specified above, the maximum st  - Failure to reply within the set or extended period for reply  - Any reply received by the Office later than three months a earned patent term adjustment. See 37 CFR 1.704(b).	ICATION.  s of 37 CFR 1.136(a). In no event, however, may a repulsion.  10) days, a reply within the statutory minimum of thin atutory period will apply and will expire SIX (6) MON or will. by statute, cause the application to become AE	eply be timely filed by (30) days will be considered timely ITHS from the mailing date of this co SANDONED (35 U.S.C. § 133).	mmunication.				
Status 1)⊠ Responsive to communication(s) fi	led on 25 February 2003						
, <u> </u>	2b)⊠ This action is non-final.						
/-	,—	tters, prosecution as to the	e merits is				
3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.							
Disposition of Claims							
4)⊠ Claim(s) <u>1-4</u> is/are pending in the a							
4a) Of the above claim(s) is/a	are withdrawn from consideration.						
5) Claim(s) is/are allowed.							
6)⊠ Claim(s) <u>1-4</u> is/are rejected.							
7) Claim(s) is/are objected to.							
8) Claim(s) are subject to restrict	ction and/or election requirement.						
Application Papers							
9) The specification is objected to by th		h - Francisco					
10) The drawing(s) filed on is/are:							
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).							
11) The proposed drawing correction filed on is: a) approved b) disapproved by the Examiner.							
If approved, corrected drawings are required in reply to this Office action.							
12) The oath or declaration is objected to	b by the Examiner.						
Priority under 35 U.S.C. §§ 119 and 120		0.440(-).(-1)(6)					
13) Acknowledgment is made of a claim	n for foreign priority under 35 U.S.C.	§ 119(a)-(d) or (i).					
a)⊠ All b)□ Some * c)□ None of:							
1. Certified copies of the priority							
<del></del>	documents have been received in A		0.1				
<ul> <li>3. Copies of the certified copies application from the Interest</li> <li>* See the attached detailed Office action</li> </ul>	of the priority documents have been national Bureau (PCT Rule 17.2(a)). on for a list of the certified copies not		Stage				
14) Acknowledgment is made of a claim			application).				
a)  The translation of the foreign la	nguage provisional application has b	een received.					
Attachment(s)							
1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (I 3) Information Disclosure Statement(s) (PTO-1449) F	PTO-948) 5) Notice of	Summary (PTO-413) Paper Not Informal Patent Application (PTo .					

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#### **DETAILED ACTION**

# **Double Patenting**

The nonstatutory double patenting rejection is based on a judicially created doctrine grounded in public policy (a policy reflected in the statute) so as to prevent the unjustified or improper timewise extension of the "right to exclude" granted by a patent and to prevent possible harassment by multiple assignees. See *In re Goodman*, 11 F.3d 1046, 29 USPQ2d 2010 (Fed. Cir. 1993); *In re Longi*, 759 F.2d 887, 225 USPQ 645 (Fed. Cir. 1985); *In re Van Ornum*, 686 F.2d 937, 214 USPQ 761 (CCPA 1982); *In re Vogel*, 422 F.2d 438, 164 USPQ 619 (CCPA 1970);and, *In re Thorington*, 418 F.2d 528, 163 USPQ 644 (CCPA 1969).

A timely filed terminal disclaimer in compliance with 37 CFR 1.321(c) may be used to overcome an actual or provisional rejection based on a nonstatutory double patenting ground provided the conflicting application or patent is shown to be commonly owned with this application. See 37 CFR 1.130(b).

Effective January 1, 1994, a registered attorney or agent of record may sign a terminal disclaimer. A terminal disclaimer signed by the assignee must fully comply with 37 CFR 3.73(b).

Claims 1-4 are rejected under the judicially created doctrine of obviousness-type double patenting as being unpatentable over claims 1-5 of U.S. Patent No. 6,180,962 in view of Glenn et al. (US 6,228,676).

With regard to claim 1, US 6,180,962 discloses a semiconductor light-emitting device comprising:

- A substrate (claim 1);
- A pair of electrodes, at least one of the pair of electrodes including an inner
  portion and an outer portion, the inner portion of the at least one of the pair of
  electrodes residing in the same plane as the outer portion of the at least one of the
  pair of electrodes (claim 1);
- A semiconductor light-emitting chip electrically connected to said pair of electrodes (claim 1);

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A mold encapsulating the semiconductor light-emitting chip, the mold
encapsulating the inner portion of at least one of the pair of electrodes, the outer
portion of at least one of the pair of electrodes extending substantially laterally
beyond the mold (claim 1);

• A step formed in the inner portion of at least one of the pair of electrodes at an inside of said mold and having a height increasing from an outer side to an inner side of the mold (claim 1 and 5).

With regard to claim 2 and in according to claim 1 above, US 6,180,962 discloses the electrode includes a step, but does not disclose the electrode is a Cu layer and the step being formed by changing a thickness of the Cu layer. However, Cu is a well-known material for electrode such as disclosed by Glenn et al. (Glenn col. 2, line 67 to col. 3, line 1). Therefore, it would have been obvious to have a Cu layer as the electrode. Glenn et al. disclose a step formed by changing the thickness of the electrode (Glenn fig. 1).

With regard to claims 3 and 4, US 6,180,962, modified by Glenn et al. in claim 2 above, would disclose an Au layer formed in an uppermost layer of the electrode (Glenn col. 3, lines 4-8).

## Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person

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having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claims 1-4 are rejected under 35 U.S.C. 103(a) as being unpatentable over Ohno et al. (US 5,227,662) in view of Ishinaga (US 5,936,264).

With regard to claim 1, Ohno et al. disclose a composite lead frame and semiconductor device (col. 3, line 25 to col. 7, line 30 and fig. 7) comprising:

- A pair of electrode, having an inner portion 12 and an outer portion 10, where the inner portion residing in the same plane as the outer portion (fig. 7);
- A mold 38 encapsulating the chip 34 and the mold 38 encapsulating the inner portion of the electrode 12 and the outer portion 10 extending substantially laterally beyond the mold 38 (fig. 7);
- A step 28 formed in the inner portion 12 of the electrode inside the mold 38 and the step 28 having a height increasing from an outer side to an inner side of the mold 38 (fig. 7);
- Ohno et al. do not disclose the IC chip is a light-emitting chip. However, it is
  common in the art to encapsulate a light-emitting chip with this method such as
  disclosed in Ishinaga (Ishinaga fig. 1). Therefore, it would have been obvious the
  IC chip could be an light-emitting chip.

With regard to claim 2 and in according to claim 1 above, Ohno et al. disclose the electrode includes a Cu layer (col. 7, lines 5-6) and the step being formed by changing the thickness of the Cu layer (fig. 7).

With regard to claims 3-4 and in according to claim 2 above, Ohno et al. disclose an Au layer formed in an uppermost layer (col. 6, lines 41-43).

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#### Response to Arguments

Applicant's arguments with respect to claims 1-4 have been considered but are moot in view of the new reference cited and new ground(s) of rejection.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Wai-Sing Louie whose telephone number is (703) 305-0474. The examiner can normally be reached on 7:30 AM to 4:00 PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Wael Fahmy can be reached on (703) 308-4918. The fax phone numbers for the organization where this application or proceeding is assigned are (703) 308-7722 for regular communications and (703) 308-7722 for After Final communications.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is (703) 308-0956.

wsl March 12, 2003